



# TVGA8900D SUPER VGA CONTROLLER

## Overview

- Single-chip solution for IBM PC/AT and compatible, PS/2 and compatible
- Built-in data bus transceiver and feature connector support
- Only one 32Kb EPROM required to achieve 16-bit BIOS operation speed
- Fully hardware compatible with VGA, EGA, CGA, MDA, and Hercules at the register level
- Programmable DRAM timing
- Supports 256Kx4, 256Kx8, 256Kx16, 512Kx4 and 512Kx8 DRAM chips
- Requires only two 256Kx4 DRAM chips for VGA solution
- Supports up to 1 MB of DRAM
- Supports 640x400, 640x480, 800x600, 1024x768 (interlaced or non-interlaced) in 256 colors
- Supports 800x600, 1024x768, and 768x1024 (interlaced or non-interlaced) in 16 colors
- Supports 640x400, 640x480, and 800x600 in 32K/64K colors (Trident's TKD8001 or other 15/16-bit DAC required)
- Supports 640x480 16M color mode (Trident's TKD8001 or other 24-bit DAC required)
- Supports 1024x768x256 72Hz non-interlaced
- Supports 70Hz refresh at 800x600 and 1024x768
- Supports Edsun CEG™ DAC
- Zero-wait state ISA bus performance
- Supports linear addressing
- Supports 80/132-column text in 25, 30, 43, or 60 rows
- High-resolution drivers available
- 0.8 µm low power CMOS technology
- 160 pin PFP package

## General Description

The TVGA8900D is the successor to the popular TVGA8900CL and TVGA8900C. The TVGA8900D is a highly integrated and cost effective solution for high performance VGA (Video Graphics Array) systems. The built-in data bus transceiver and feature connector support mean a minimum motherboard solution can be achieved with only three support chips: the TKD8001 Truecolor DAC/clock chip, and two pieces 256Kx4 DRAM. Programmable DRAM timing allows the designer to choose either slower speed DRAM for a cost saving solution or faster speed DRAM for high speed performance. Display support for Super VGA, VGA, EGA, CGA, and MDA monitors assures TVGA8900D solutions can be matched up with virtually any monitor on the market.

The TVGA8900D also provides improved speed over the TVGA8900CL and TVGA8900C. This is achieved by zero-wait state direct memory write ISA bus performance, faster base DRAM clock (48MHz), and 1 MB linear addressing. The linear addressing eliminates memory bank switching and increases the speed for software that accesses more than 256K of memory.



## TVGA8900D DATA SHEET

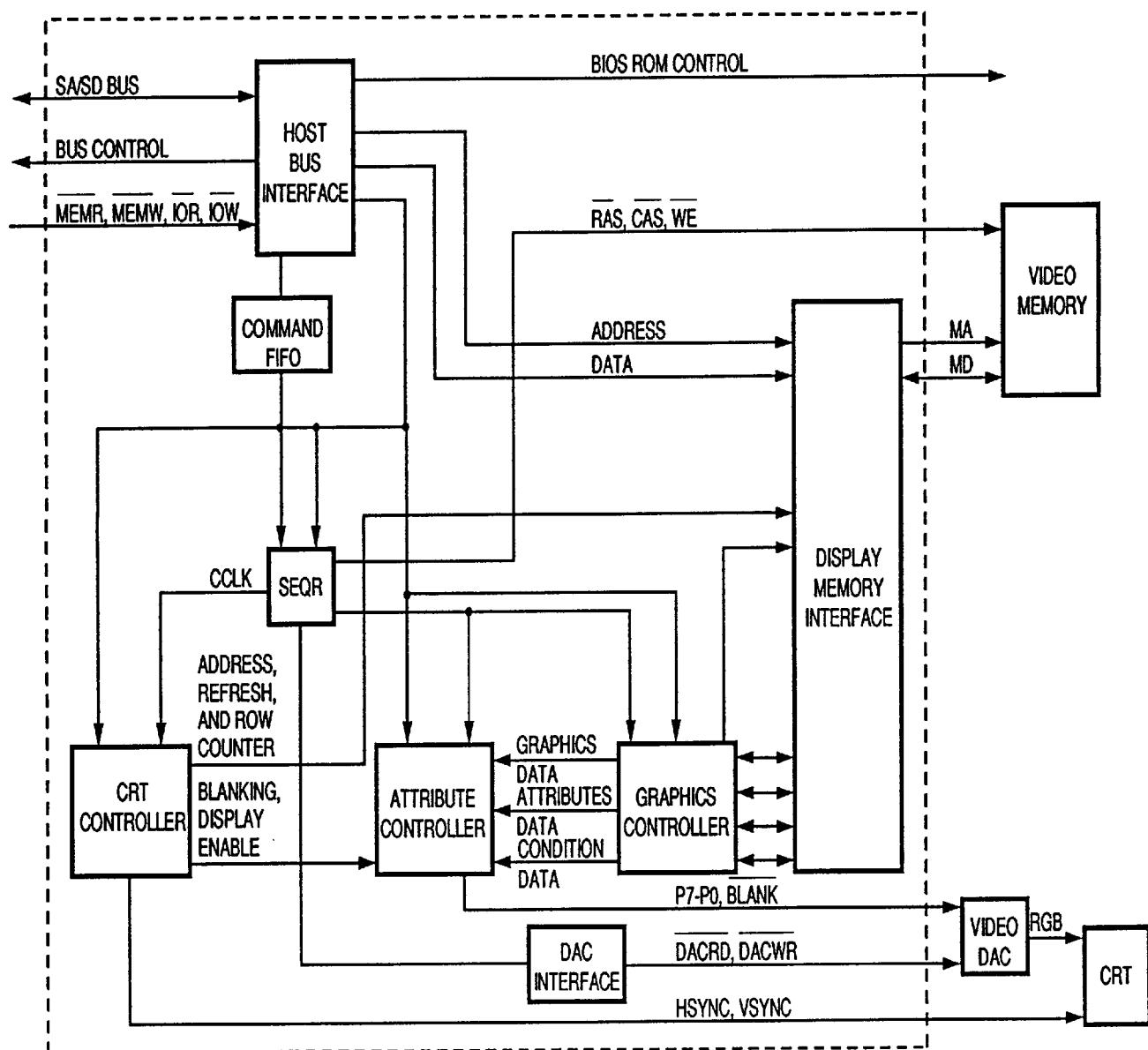


Figure 1. TVGA8900D Functional Block Diagram

## Compatibility

The TVGA8900D is fully compatible with all standard IBM VGA modes and EGA, CGA, MDA, and Hercules modes, and allows:

- Use of application software that uses any of the above modes
- Emulation of EGA, CGA, MDA, and Hercules modes on a VGA monitor

## Extended Graphics and Text Modes

Extended graphics modes supported include:

- 640x400, 640x480, and 800x600 in 32K or 64K colors
- 640x480 in 16M colors
- 640x400, 640x480, 800x600, and 1024x768 (interlaced or non-interlaced) in 256 colors from a palette of 256K colors (with 6-bit DAC) or 16M colors (with 8-bit DAC)
- 800x600, 768x1024, and 1024x768 (interlaced or non-interlaced) and 1280x1024 (interlaced) in 16 colors out of 256K/16M
- 1024x768 in 4 colors out of 256K/16M
- Extended text modes offer 80-column text with 30, 43, and 60 rows; and 132-column text with 25, 30, 43, and 60 rows

## Hardware Features

The TVGA8900D supports PC/AT bus and PS/2 Micro Channel bus and offers speed improvement and flexible memory type selections over the TVGA8900CL.

The support of pseudo 16-bit ROM operation in TVGA8900D means high performance can be achieved using a single ROM chip. A single ROM solution helps minimize the number of chips required for VGA implementation.

The chip allows programmable DRAM timing and

supports 256Kx4, 256Kx8, 256Kx16, 512Kx4 and 512Kx8 DRAM. Table 1 outlines the amount and speed of Fast Page Mode 256Kx4 DRAM required to implement the 16-, 256-, 32K-, and 16M-color modes. For other types of DRAM, typically 80ns speed is required.

**Table 1. 16, 256, 32K, and 16M-Color DRAM Requirements**

Resolution	16	Colors		DRAM Count				Speed ns	
		256	32K	16M	2	4	8	100	80
Standard VGA	•				•				•
640x480		•				•			•
640x480			•			•			•
640x480				•					•
800x600	•				•				•
800x600		•				•			•
800x600			•			•			•
1024x768 (Interlaced)	•					•			•
1024x768 (Non-interlaced)	•					•			•
1024x768 (Interlaced)		•				•			•
1024x768 (Non-interlaced)		•				•			•
1280x1024 (Interlaced)	•					•			•

\*Same DRAM requirement for 64K color

A CPU command FIFO allows zero-wait state performance on the PC/AT and MCA bus. On the display side, base DRAM clock speed has improved and linear addressing eliminates bank switching overhead for all display resolutions.

## Software Drivers Supported

The TVGA8900D is compatible with all drivers currently available for the TVGA8900CL. The following applications are supported:

- |                                     |             |            |
|-------------------------------------|-------------|------------|
| ■ AutoCAD                           | ■ Autoshade | ■ CADKEY   |
| ■ Framework                         | ■ GEM       | ■ Lotus    |
| ■ MS Windows                        | ■ MS Word   | ■ P-CAD    |
| ■ Symphony                          | ■ Ventura   | ■ VersaCAD |
| ■ WordPerfect                       | ■ Wordstar  | ■ OS/2     |
| ■ SCO X-Windows (contact SCO)       |             |            |
| ■ Edsun CEG™ (Windows, Lotus, ACAD) |             |            |

Contact Trident for the latest high-resolution driver releases.



## TVGA8900D Applications

The TVGA8900D works with your hardware allowing you to develop a high-end or low-end system. You can use Trident's DAC/clock chip, the TKD8001, to select up to 16 different clock frequencies. Such frequency selection ability allows you to implement specific applications such as support for high-resolution analog VGA monitors, fixed-frequency VGA monitors, and EGA, CGA, MDA, and Hercules monitors. The TVGA8900D allows you to divide clock input frequencies by one and one half, two, or four. Four chips signals (SC1, SC2, SC3, and SC4) can be programmed to select specific clock inputs for the TVGA8900D.

A minimum configuration requires a TVGA8900D, TKD8001 DAC/clock chip, two 256Kx4 DRAM chips, 32KB EPROM, 15-pin connector, 14.318MHz crystal, jumpers, and miscellaneous ferrite beads, capacitors, resistors.

## TVGA8900D Components

The TVGA8900D consists of eight major components: Sequencer, CRT Controller, Graphics Controller, Attribute Controller, DAC Support Logic, Host Bus Interface, Display Memory Bus Interface and Command FIFO. These components are used to generate video output and timing for video memory and the monitor. See Figure 1 on page 2 for the TVGA8900D Functional Block Diagram.

### Sequencer

The sequencer provides basic memory timing for DRAM interfacing, and a character clock for the CRTC and for controlling regenerative memory fetch. The sequencer uses a 32 byte video cache to let the CPU access display memory during active display intervals. Video data from the cache can be output to the video screen while the CPU accesses video memory. This greatly increases performance over standard implementations for CPU access.

### CRT Controller

The CRT (Cathode Ray Tube) Controller provides complete control for horizontal and vertical synchronous timing, address interface between video memory and display screen, cursor and underline timing, and refresh addressing for dynamic RAMs.

### Graphics Controller

During the active display interval, the Graphics Controller directs data from video memory to the Attribute Controller. In graphics modes, memory data is formatted into serialized form and sent to the Attribute Controller in 4-bit plane format. In text mode, the parallel attribute byte goes directly to the Attribute Controller without going through the Graphics Controller. During video memory read/write operations, the Graphics Controller acts as an interface to the CPU. The Graphics Controller can perform logic operations on memory data before it reaches the display memory or system data bus.

### Attribute Controller

The Attribute Controller takes in data from video memory and formats it for output on the display monitor. In addition, the Attribute Controller takes care of blinking, underlining, cursor insertion, and PEL panning. In text mode, 16 bits of code are divided into 8 bits of character code and 8 bits of attribute code. The character code is used as a look-up into a font table. The attribute code is used to determine character color, blinking, bold, etc. In graphics mode, the Graphics Controller serializes memory bits. Each output color is translated through the internal color palettes and then sent to the Video DAC. Here it is used as an address to the 18/24-bit color look-up table. The value read from the color look-up table is converted into three analog signals (R, G, B) for driving an analog display.



## DAC Support Logic

To simplify the chip hardware design, the TVGA8900D provides a pixel clock and DAC write, DAC read, and blank signals to an off-chip color look-up table/DAC. See Figure 7-A and 7-B for diagrams of standard applications (page 14 and 15). 15/16-bit color and true color DACs are supported.

## Host Bus Interface

The TVGA8900D supports the PC/AT bus and the Micro Channel bus by setting or resetting configuration bits MD4 during the system reset time. When the TVGA8900D is part of a Micro Channel board solution, several host bus interface pins are defined or designated differently from a PC/AT solution. Reference Table 10 for details.

The TVGA8900D video ROM is located at C0000-C7FFF. The PROM data width can be configured as 16-bit or 8-bit at system reset time by pulling MD7 high or low, respectively. If the 16-bit mode is turned on, the TVGA8900D will return MCS16 when the PROM is addressed. If the on-board BIOS is not used, the ROM chip(s) can be disabled by pulling MD6 low at system reset time.

The TVGA8900D can address up to 1MB of video memory depending on the mode (text or graphics). After system reset the TVGA8900D is configured for an 8-bit data width for video memory access. The 16-bit-wide data bus can be activated automatically by ROM. The TVGA8900D will drive MCS16 when the 16-bit mode is set and video memory is accessed.

In order to comply with the Micro Channel specifications, the TVGA8900D supports channel ID (I/O address 100 and 101) as well as the card-enable control bit (bit 0 of I/O port 102). When the video memory or on-board I/O registers are accessed, the TVGA8900D responds with CD SFDBK. CD SFDBK is generated by decoding the following address groups with a read/write command:

### I/O Read/Write:

- 3BX - excluding 3B6, 3B7, 3BC, 3BD, and 3BX. For monochrome mode only.
- 3DX - excluding 3D6, 3D7, 3DE, and 3DF. For color mode only.
- 3CX - excluding 3CA, 3CB, and 3CD.

### Memory Read/Write:

- ROMCS - on-board BIOS EPROM address from C0000 to C7FFF.
- MEMR/W - default display memory address space.

Since there is only the decoding delay for generation of CD SFDBK, the signal will look very much like that of a system read/write command.

## Display Memory Bus Interface

The TVGA8900D provides a bus interface for the video display DRAM. The interface provides address multiplexing, data multiplexing, refresh, and RAS, CAS, and write-enable signals. Nineteen address pins (MA9, MAA8-MAA0 and MAB8-MAB0 for Bank A and B) and 32 data pins (MD31-MD0) are available for display memory.

## Command FIFO

The FIFO enhances the memory write performance. CPU write data is stored in the FIFO without being written into memory so the CPU does not have to wait when the video interface is busy. When the memory bus is available, data is written into memory from the FIFO.



## T V G A 8 9 0 0 D D A T A S H E E T

**MD & RMD Definitions at System Reset**

Tables 2 through 4 list values and definitions for MD29-MD16, MD7-MD0 and RMD7-RMD0 at system reset.

**Table 2. MD29-MD16 Definitions**

MD	Logic Value <sup>1</sup>	Definition
MD29	-	Default logic value 1
MD28	0	Pins WE3-WE0 defined as CASA3-CASA0. Pin CASA defined as WE
	1	Default
MD27-MD24	NA	Sets base address of the linear address window
MD23	0	Enables true color mode
	1	Disables true color mode
MD22	NA	Reserved
MD21	0	Reserved
	1	ISA/MCA bus
MD20	NA	Reserved
MD19-MD18	00	Supports 256Kx16 DRAM. Pin 158 is not used
	01	Supports 512Kx8 DRAM. Pin 158 is used as MA9
	10	Reserved
	11	Supports 256Kx4 or 256Kx8 DRAM up to 1MB. Pin 158 is used as NMI.
MD17	0	Selects LA23-20
	1	Selects SA19-17, HAD
MD16	0	8-bit ISA bus
	1	16-bit ISA bus
MD15	NA	Reserved

<sup>1</sup>No pull-up resistor required to set a Logical 1 value. Set a Logical 0 value by pulling-down to GND through a 4.7K-10K resistor.

**Table 3. MD7-MD0 Definitions**

MD	Logic Value <sup>1</sup>	Definition
MD7	0	8-bit BIOS
	1	16-bit BIOS
MD6	0	ROM disabled
	1	ROM enabled
MD5	0	I/O port at 2xx
	1	I/O port at 3xx
MD4	0	MCA bus
	1	ISA bus
MD3-MD0		DIP switch settings <sup>2</sup>

<sup>1</sup>No pull-up resistor required to set a Logical 1 value. Set a Logical 0 value by pulling-down to GND through a 4.7K-10K resistor.

<sup>2</sup>Data read into a 4-bit register. The data values can be used by the BIOS or application software.



Table 4. RMD7-RMD0 Definitions

RMD	Logic Value <sup>1</sup>	Definition
RMD7	0	8-bit video memory
	1	16-bit video memory
RMD6-RMD5	00	Reserved
	01	8-bit DRAM data bus
	10	16-bit DRAM data bus
	11	32-bit DRAM data bus
RMD4	0	Selects 46E8 for port control
	1	Selects 3C3 for port control
RMD3	0	24K BIOS
	1	32K BIOS
RMD2	1	Reserved
RMD1	0	Standard BIOS wait states
	1	Extended BIOS wait states
RMD0	0	Slow mode address detect
	1	Fast mode address detect

## Chip Specifications

Table 5. Absolute Maximum Ratings

Parameter	Symbol	Minimum	Typ.	Maximum	Units
Power Supply Voltage	V <sub>DD</sub>	4.75	5.0	5.25	V
Input Voltage	V <sub>IN</sub>	GND		V <sub>DD</sub>	V
Operating Temperature	T <sub>OP</sub>	0		70	°C
Storage Temperature	T <sub>STO</sub>	-40		100	°C

Stresses above those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to absolute maximum ratings for extended periods may effect device reliability.

Table 6. DC Specifications

Parameter	Symbol	Minimum	Maximum	Units	Conditions
Input Low Voltage	V <sub>IL</sub>	GND	0.8	V	V <sub>DD</sub> =5V
Input High Voltage	V <sub>IH</sub>	2.0	V <sub>DD</sub>	V	V <sub>DD</sub> =5V
Input Low Current	I <sub>IL</sub>	-	-0.5	μA	V <sub>IN</sub> =0.0V
Input High Current	I <sub>IH</sub>	-	20	μA	V <sub>IN</sub> =V <sub>DD</sub>
Output Low Voltage	V <sub>OL</sub>	-	0.4	V	see Note 1
Output High Voltage	V <sub>OH</sub>	2.4	-	V	see Note 1
High Impedance Leakage	I <sub>OZ</sub>	-	10.0	μA	V <sub>SS</sub> <V <sub>OUT</sub> <V <sub>DD</sub>
Supply Current	I <sub>OC</sub>	-	100.0	mA	V <sub>DD</sub> =5.25V (V <sub>DD</sub> MAX.)

Note 1: I<sub>OZ</sub>/I<sub>OH</sub> = 4/-4 mA for SC4-SC1, ROMCS, EXTCLOCK, EXENPD, DACRD, DACWR, ESYNC, RS2-RS0. I<sub>OL</sub>/I<sub>OH</sub> = 6/-6 mA for MAA8-MAA0, MAB8-MAB0. I<sub>OL</sub>/I<sub>OH</sub> = 8/-8 mA MD31-MD0, SD15-SD0, IREQ, P7-P0, VSYNC, HSYNC, BLANK, WE3-WE0/CAS3-CAS0, PCLK. I<sub>OL</sub>/I<sub>OH</sub> = 16/-16 mA for RAS, IOCHRDY, NMI, MCS16, ZWS



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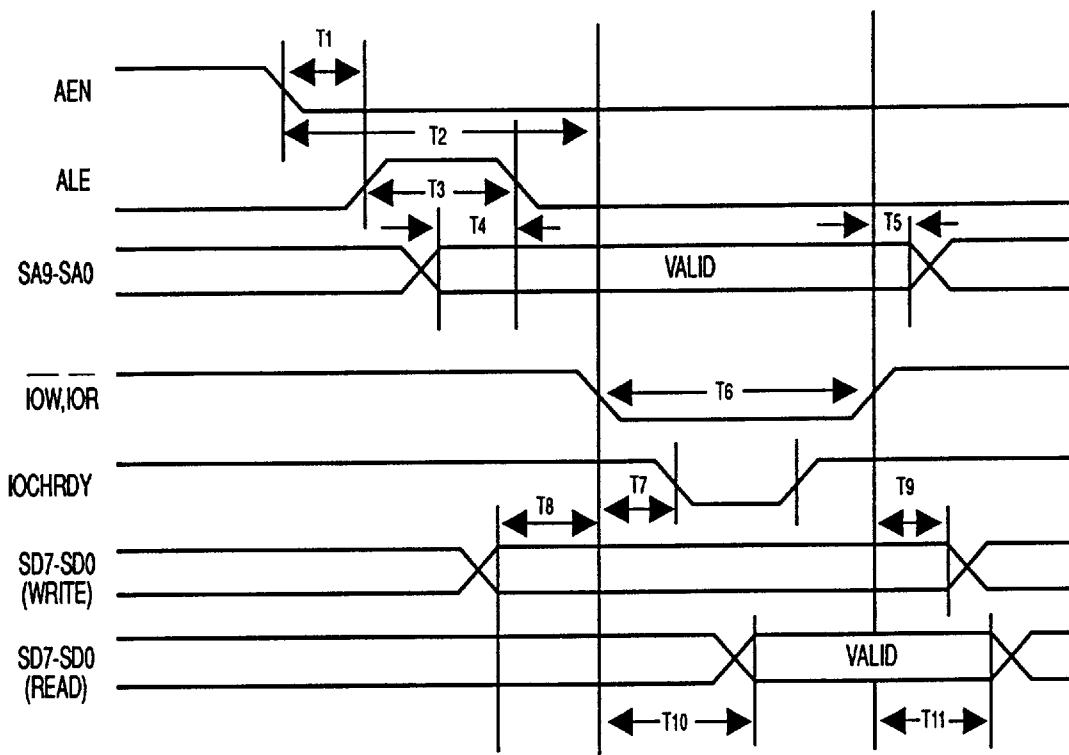


Figure 2. PC/AT ISA Bus I/O Read/Write Timing

Table 7. AC Specifications for ISA Bus I/O Read/Write in Nanoseconds

SYM	Description	Min	Typ	Max
T1	AEN Valid to Rising Edge of ALE	100		
T2	AEN Valid to I/O Command Active	5		
T3	ALE Active to Inactive	15.5		
T4	SA9-SA0 & SBHE Valid to Falling Edge of ALE	29.5		
T5	SA9-SA0 & SBHE Valid Hold From Command Inactive	18		
T6	I/O Command Active		60	
T7	IOCHRDY Inactive From Active Command	10		15
T8	Valid Write Data Setup to I/O Command Active	4.5		80
T9	Write Data Valid Hold From I/O Command Inactive	30		
T10	Read Data Valid From Read Command Active		60	
T11	Read Command Inactive to SD7-SD0 Invalid		20	

## T V G A 8 9 0 0 D D A T A S H E E T

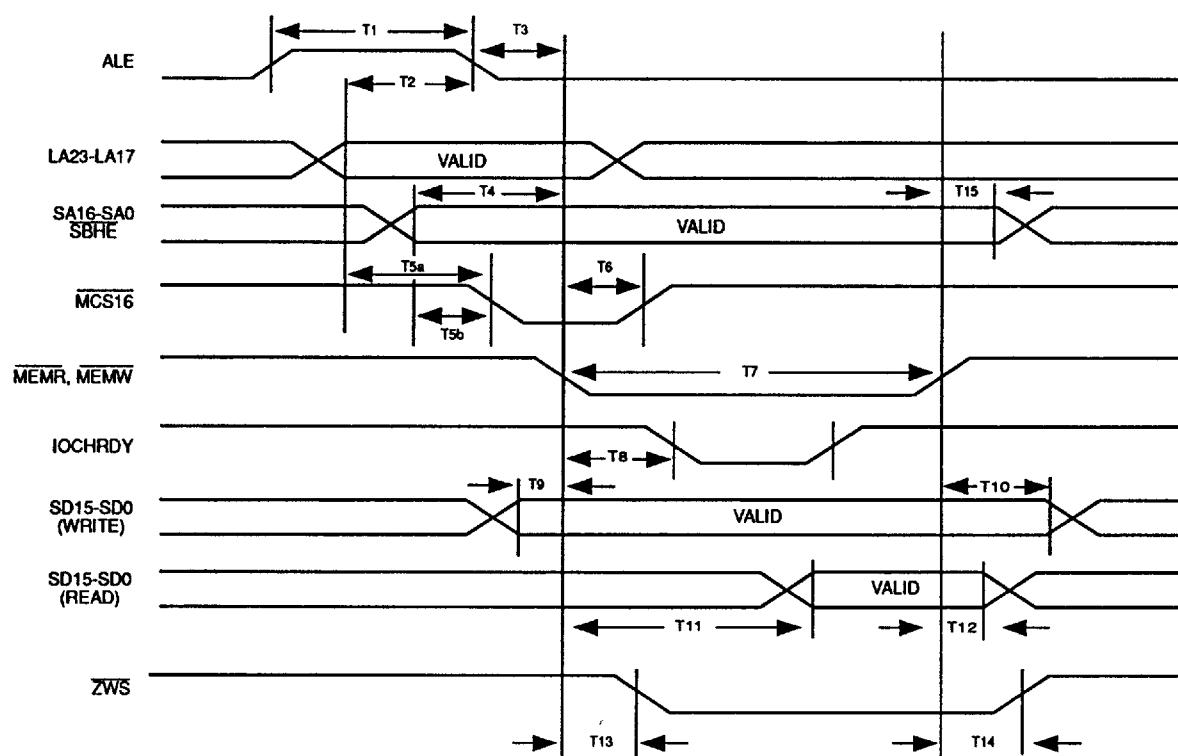



Figure 3. PC/AT ISA Bus Memory Read/Write Timing

Table 8. AC Specifications for ISA Bus Memory Read/Write In Nanoseconds

SYM	Description	Min	Typ	Max
T1	ALE Active to Inactive	15		
T2	LA23-LA17 Valid Setup to Falling Edge of ALE	20		
T3	ALE Inactive to Command Active	20		
T4	SA16-SA0 & SBHE Valid to Memory Command Active	5		
T5a	MCS16 Active From Unlatched Address		20	
T5b	MCS16 Active From Latched Address		14	
T6	MCS16 Valid Hold From Invalid LA23-LA17		25	
T7	Memory Command Active to Inactive	80		
T8	IOCHRDY Inactive From Memory Command Active	10	20	
T9	Valid Write Data Setup to Memory Command Active	0		
T10	Write Data Valid Hold From Memory Command Inactive	10		
T11	Valid Read Data From Memory Command Active	0		
T12	Read Command Inactive to SD15-SD0 Invalid		20	
T13	ZWS Active From Command Active	8	15	
T14	ZWS Inactive From Command Inactive	10	15	
T15	Latched Address Hold Time After Command	0		



## T V G A 8 9 0 0 D D A T A S H E E T

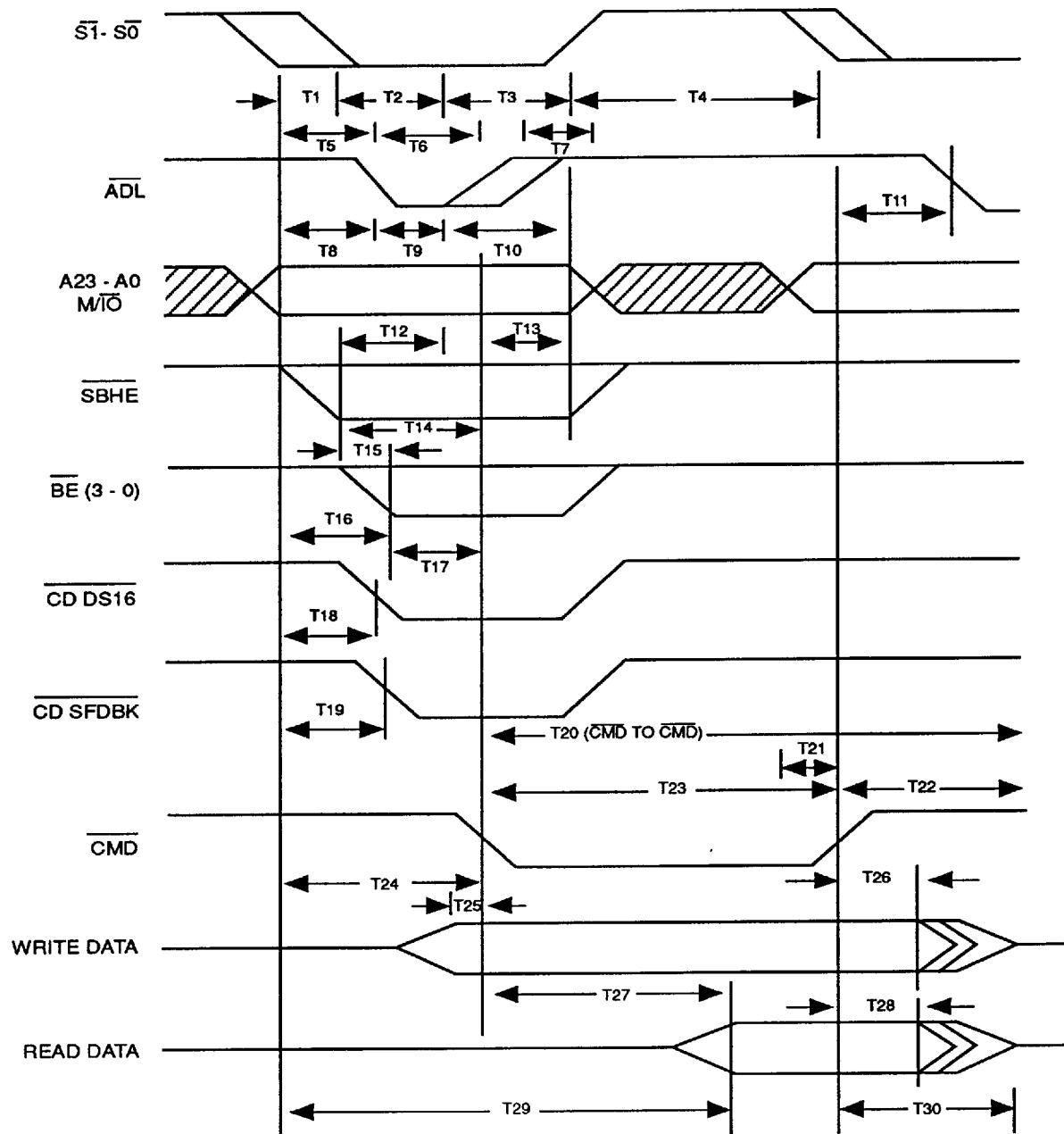


Figure 4. Micro Channel Bus Timing

## T V G A 8 9 0 0 D D A T A S H E E T

**Table 9. AC Specifications for MCA Bus in Nanoseconds**

SYM	Description	Min	Typ	Max
T1	Status Active From ADDRESS, M/I/O, REFRESH	10		
T2	CMD Active From Status Active	55		
T3	Status Hold From CMD Active	30		
T4	Next Status Active From Status Inactive	30		
T5	ADL Active From ADDRESS, M/I/O, REFRESH	45		
T6	ADL Active to CMD Active	40		
T7	ADDRESS, M/I/O, REFRESH, SBHE hold from ADL Inactive	25		
T8	ADL Active from Status Active	12		
T9	ADL Active to Inactive	40		
T10	Status Hold From ADL Inactive	25		
T11	CMD Inactive to next ADL Active	40		
T12	SBHE Setup to ADL Inactive	40		
T13	ADDRESS, M/I/O, REFRESH, SBHE Hold From CMD Active	30		
T14	SBHE Setup to CMD Active	40		
T15	BE3-BE0 Active From SBHE, A0, A1 Active			30
T17	BE3-BE0 Active to CMD Active	10		
T18	CD DS 16 Active (n) From ADDRESS, M/I/O, REFRESH Valid			55
T19	CD SFDBK Active From ADDRESS, M/I/O, REFRESH Valid	60		
T20	CMD Active to Next CMD Active	190		
T21	Next Status Active to CMD Inactive		20	
T22	CMD Inactive to Next CMD Active	80		
T23	CMD Active to Inactive	90		
T24	CMD Active From Address Valid	85		
T25	Write Data Setup to CMD Active	0		
T26	Write Data Hold From CMD Inactive	30		
T27	Read Data Valid From CMD Active	60		
T28	Read Data Hold From CMD Inactive	0		
T29	Status to Read Data Valid			125
T30	Read Data Bus Tri-state From CMD Inactive	40		



## TVGA 8900D DATA SHEET

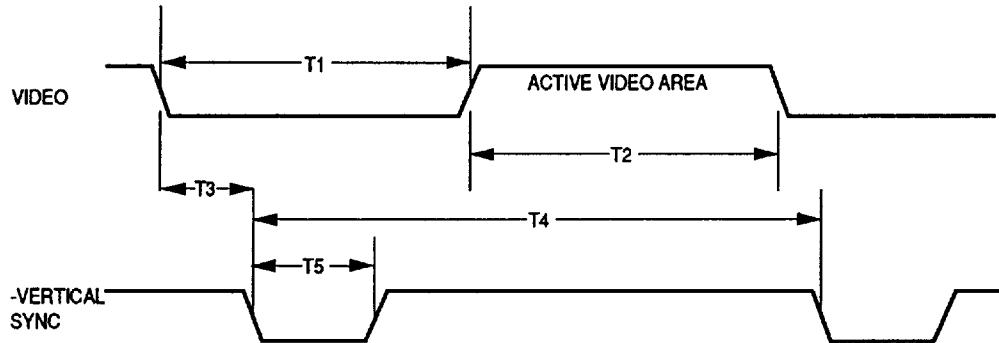
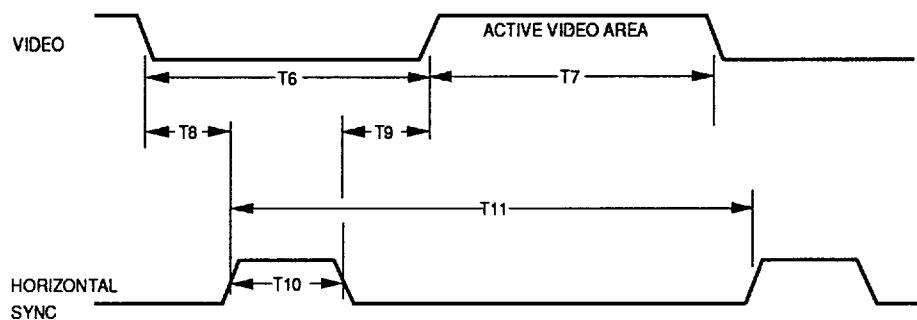
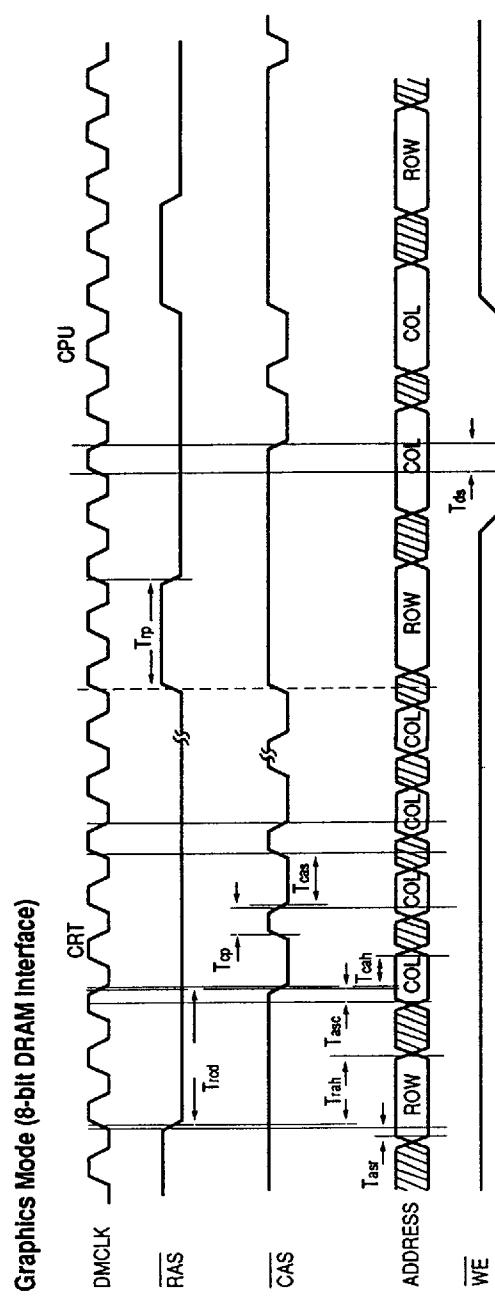


Figure 5-A. Vertical Timing (ms)

Figure 5-B. Horizontal Timing ( $\mu$ s)



## TVGA8900D DATA SHEET



Graphics Mode (16/32-bit DRAM Interface)

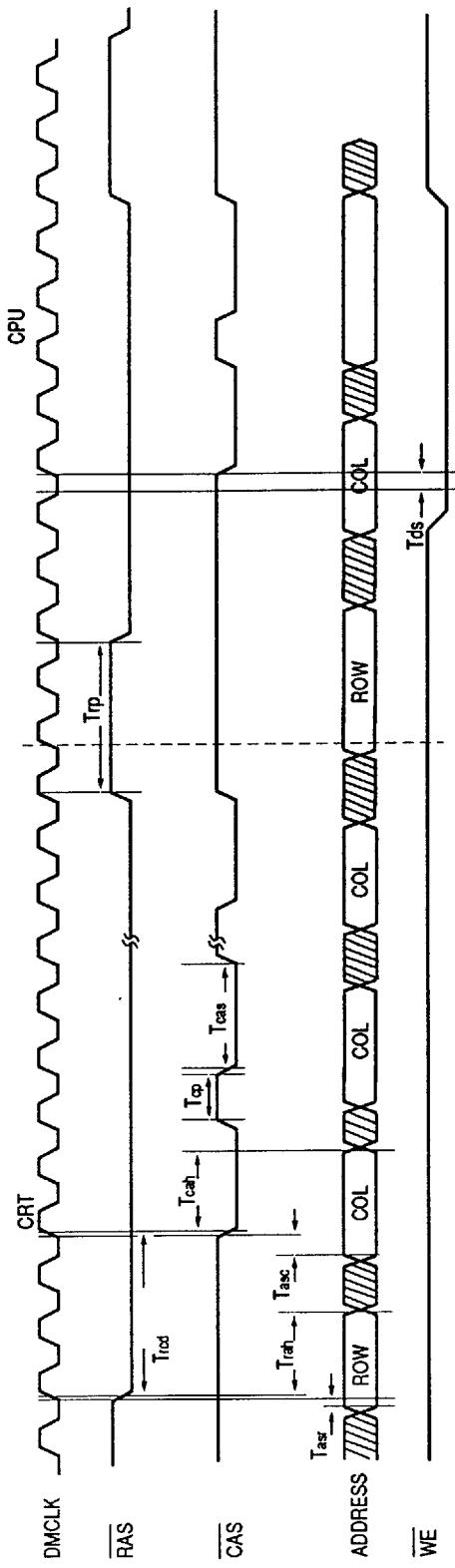


Figure 6-A. Trident TVGA8900D DRAM Timing (Graphics)

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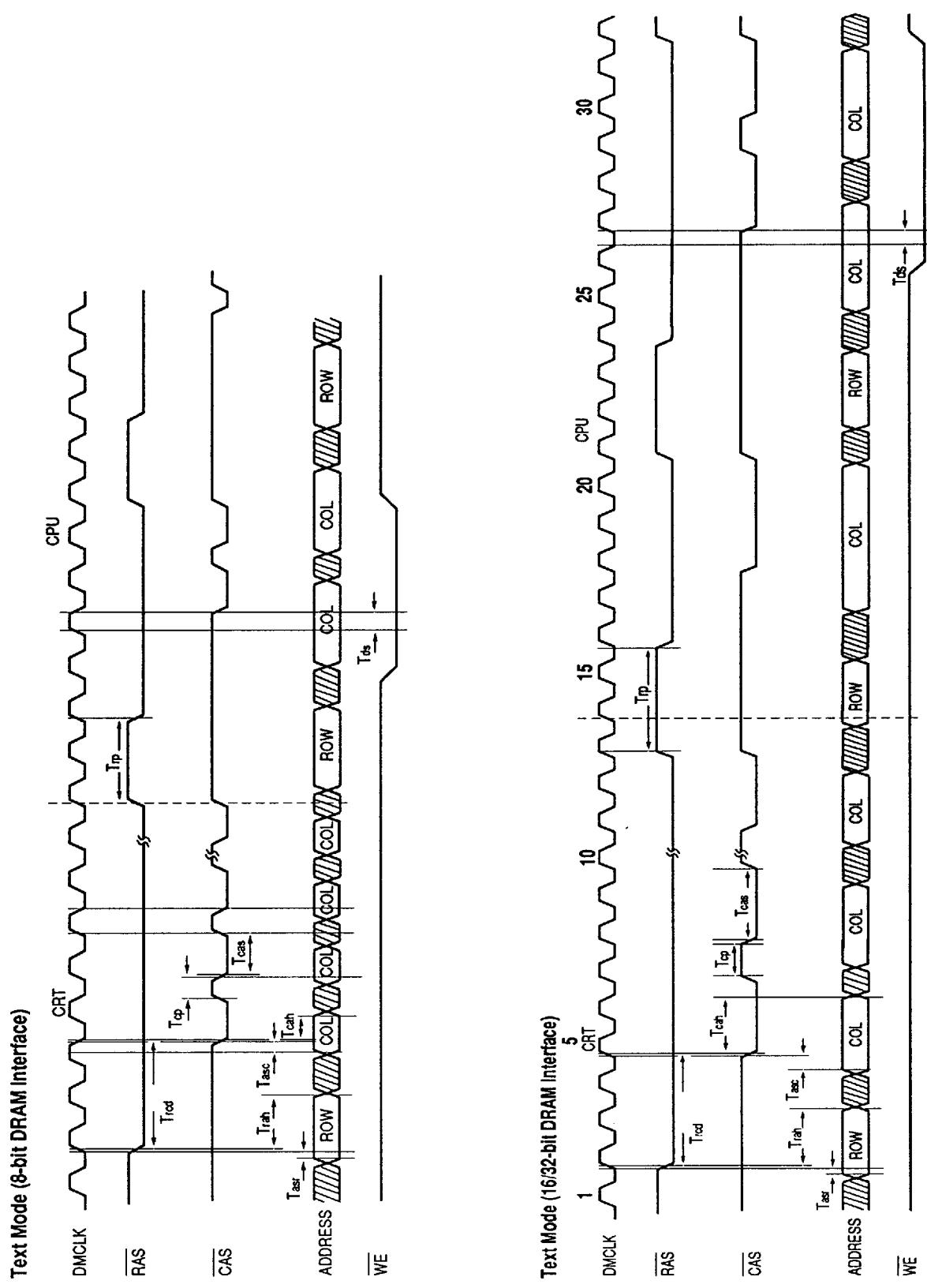



Figure 6-B. Trident TVGA8900D DRAM Timing (Text)



## T V G A 8 9 0 0 D D A T A S H E E T

Table 11. Worst Case Memory Timing Parameters<sup>1</sup>

Parameter	8 bit DRAM Interface	16 bit DRAM Interface	32 bit DRAM Interface
Trcd 1	2.5t + 1.5ns	3t + 1.5ns	3t + 3ns
Trah 2	1.5t + 2ns	2t + 2ns	2t + 2ns
Tasr 3	$\geq 0$	$\geq 0$	$\geq 0$
Tasc 4	$\geq 0.5t$	$\geq t$	$\geq t$
Tcah 5	t	2t	2t
Tcp 6	0.5t - 2.5ns	t - 5ns	t - 6ns
Tcas 7	t - 4ns	2t - 6.5ns	2t - 10ns
Tds 8	$\geq 0$	$\geq 0$	$\geq 0$
Trp 9	2t - 1.5ns	3t - 4ns	3t - 6ns
Test Load	25pf	50pf	85pf

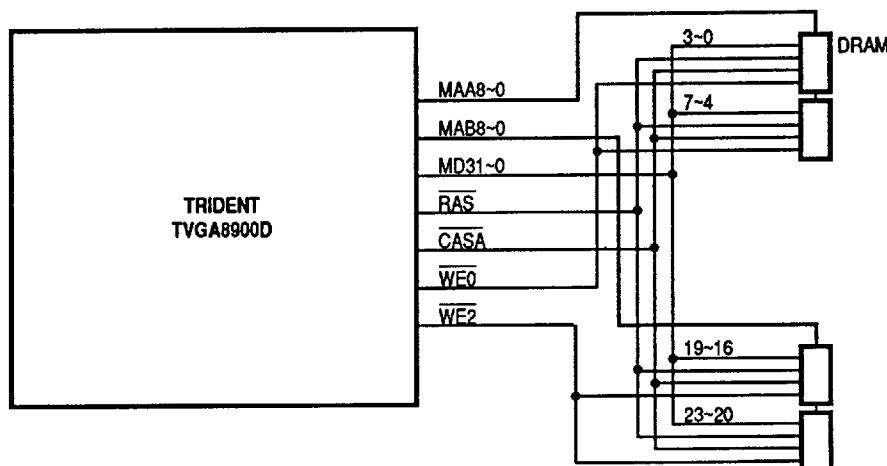
<sup>1</sup>(t=1/DMCLK)

Figure 7-A. Application For Four 256Kx4 DRAM (ISA Bus)

## TVGA8900D DATA SHEET

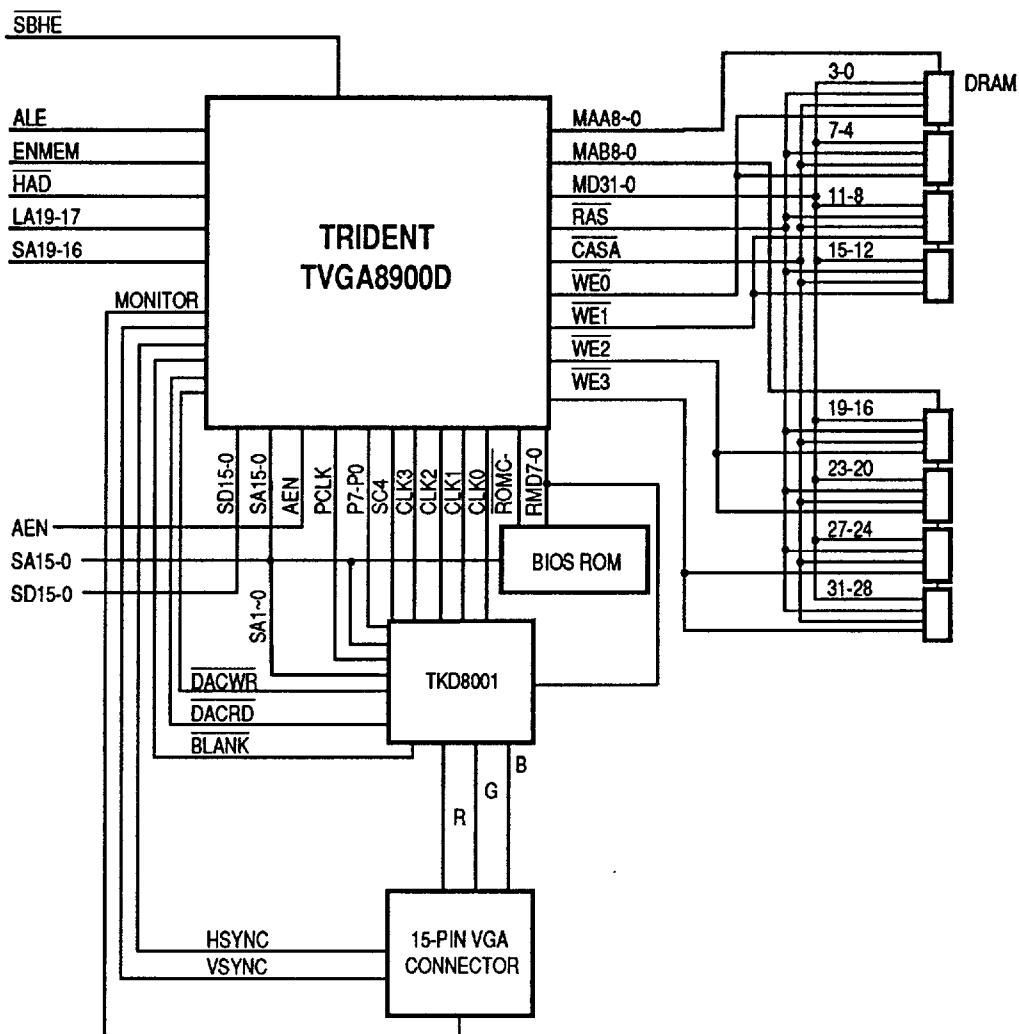
The Trident logo consists of three parallel diagonal lines forming a stylized 'T' shape, followed by the word "Trident" in a cursive script font.

Figure 7-B. Application For Eight 256Kx4 DRAM (ISA Bus)



## T V G A 8 9 0 0 D D A T A S H E E T

 Trident

 **Trident**  
**TVGA8900D**

VSS	121	120	VDD	1	80	VSS
SC4	122		D8	2	79	VSYNC
PCLK	123		D9	3	78	MAB8
SBHE	124		D10	4	77	MAB7
ADL	125		D11	5	76	MAB6
A17	126		D12	6	75	MAB5
A18	127		D13	7	74	MAB4
A19	128		D14	8	73	MAB3
A20	129		D15	9	72	MAB2
A21	130		VSS	10	71	MAB1
A22	131		D16	11	70	MAB0
A23	132		D17	12	69	MD15
A0	133		D18	13	68	MD14
A1	134		D19	14	67	MD13
A2	135		D20	15	66	MD12
A3	136		D21	16	65	VSS
A4	137		D22	17	64	MD11
A5	138		D23	18	63	MD10
A6	139		D24	19	62	MD9
A7	140		VDD	20	61	MD8
A8	141		VSS	21	60	MD7
A9	142		D25	22	59	MD6
A10	143		D26	23	58	MD5
A11	144		D27	24	57	MD4
A12	145		D28	25	56	MD3
A13	146		D29	26	55	MD2
A14	147		D30	27	54	MD1
A15	148		VDD	28	53	MD0
A16	149		D31	29	52	VSS
ENMEM	150		D32	30	51	MAA8
S1	151		D33	31	50	MAA7
CMD	152		D34	32	49	MAA6
MIO	153		D35	33	48	MAA5
S0	154		D36	34	47	MAA4
CD SETUP	155		D37	35	46	MAA3
CD CHRDY	156		D38	36	45	MAA2
RESET	157		D39	37	44	MAA1
NMI/MA9	158		D40	38	43	MAA0
CD DS16	159		VDD	39	42	ESYNC
VSS	160			40	41	VSS

Figure 8-B. TVGA8900D Pin-Out (MCA Bus)



## TVGA8900D DATA SHEET

Table 12. TVGA8900D Pin Description

Pin	Pin Type	Pin Number	Description
<i>Host Interface</i>			
<i>a. AT Bus Signals</i>			
<u>IOR</u>	I	151	I/O read strobe
<u>IOW</u>	I	152	I/O write strobe
<u>MEMR</u>	I	153	Memory read strobe
<u>MEMW</u>	I	154	Memory write strobe
<u>IOCHRDY</u>	O	156	I/O channel ready
<u>ALE</u>	I	125	System address latch enable
<u>AEN</u>	I	155	Enable on-board I/O
<u>LA19-LA17</u>	I	128-126	Unlatched address bus, bit 19 to bit 17
<u>SA19-SA17<sup>1</sup></u>	I	131-129	Address bus, bit 19 to bit 17 (Unlatched address bus, bit 22 to bit 20)
<u>(LA22-LA20)</u>			
<u>HAD(LA23)</u>	I	132	High address (Unlatched address bus bit 23)
<u>SA16-SA0</u>	I	149-133	Address Bus
<u>MCS16</u>	O	159	Enable 16-bit transfer, open drain output
<u>SD15-SD0</u>	I/O	112-119,9-2	Data bus, bit 15 to bit 0
<u>ZWS</u>	O	37	Zero wait state
<u>IRQ</u>	O	10	Interrupt request
<u>SBHE</u>	I	124	Bus high-byte enable
<u>ENMEM</u>	I	150	Enable display memory
<i>b. MCA Bus Signals</i>			
<u>S1-S0</u>	I	151,154	Status bit 1-0
<u>CMD</u>	I	152	Command
<u>M/I/O</u>	I	153	Bus memory or I/O cycle
<u>CD CHRDY</u>	O	156	Channel ready
<u>CD SETUP</u>	I	155	Card setup
<u>A23-A0</u>	I	132-126,149-133	System address bus, bit 23 to bit 0
<u>CD DS16</u>	O	159	Card data size 16-bit
<u>D15-D0</u>	I/O	112-119,9-2	System data bus, bit 15 to bit 0
<u>CD SFDBK</u>	O	37	Card select feedback
<u>IRQ</u>	O	10	Interrupt request
<u>SBHE</u>	I	124	Bus high-byte enable
<u>ENMEM</u>	I	150	Enable display memory
<u>ADL</u>	I	125	Address decode latch
<i>Common Bus Signals</i>			
<u>RESET</u>	I	157	System reset (active high); the falling edge latches configuration information into internal registers from memory data lines and AD7-AD0



Table 12. TVGA8900D Pin Description - Continued

Pin	Pin Type	Pin Number	Description
NMI/MA9	O	158	Non-maskable interrupt/additional address bus for 1MB of 512Kx8 or 256Kx16 DRAM chips
<i>Display Memory Interface</i>			
CASA/WE	O	82	Column address strobe for Bank A/memory write enable for DRAM requires multiple CAS and one memory write
<u>WE3-WE0/</u> <u>CASA3-CASA0</u>	O	84-87	Write enable/column address strobe for Bank A when DRAM requires multiple CAS and one memory write
RAS	O	83	Row address strobe
MAA8-MAA0	O	51-43	Multiplexing address bus of display memory Bank A
MAB8-MAB0	O	78-70	Multiplexed address bus of display memory Bank B
MD31-MD0	I/O	105-102,99-88 69-66,64-53	Memory data bus (bit 31 to bit 0)
DMCLK	I	110	DRAM clock
<i>Video Interface</i>			
VSYNC	O	79	Vertical synchronization pulse, polarity programmable
Hsync	O	36	Horizontal synchronization pulse, polarity programmable
RMD7-RMD0	I/O	24-31	ROM/DAC data bus bit 7 to bit 0
P7-P0	O	23-22,19-14	Video DAC address, bit 7 to bit 0
PCLK	O	123	Pixel clock output
BLANK	O	32	Blank output
DACRD	O	33	DAC read strobe
DACWR	O	34	DAC write strobe
MONITOR	I	35	Monitor type detect (analog monitor)
EVIDEO/RS2	I/O	38	External pixel data enable (feature connector)/extra DAC address (for true color mode)
EDCLK/RS3	I/O	39	External clock enable (feature connector)/extra DAC address (for true color mode)
ESYNC	I/O	42	External sync enable (feature connector)
<i>Clock Synthesizer Interface</i>			
CLK1/SC3	I/O	108	Video clock input/Clock select output 3
CLK2/SC1	I/O	107	Video clock input/Clock select output 1
CLK3/SC2	I/O	106	Video clock input/Clock select output 2
CLK0	I	109	Video clock input
SC4	O	122	Clock select, output connect to pin 1 of TCK9004
<i>BIOS Interface</i>			
ROMCS	O	12	BIOS EPROM chip select



## TVGA8900D DATA SHEET

Table 12. TVGA8900D Pin Description - Continued

Pin	Pin Type	Pin Number	Description
ROMBA0	O	11	BIOS EPROM address bit 0
<i>Other External Interfaces</i>			
MONITOR	I	35	Monitor type detect (analog monitors)
<i>Power Pins</i>			
VSS	GND	13,21,41,52,65,80 101,111,121,160	Ground
VDD	PWR	1,20,40,81,100,120	+5VDC

\*Pins definition in parentheses are for linear addressing

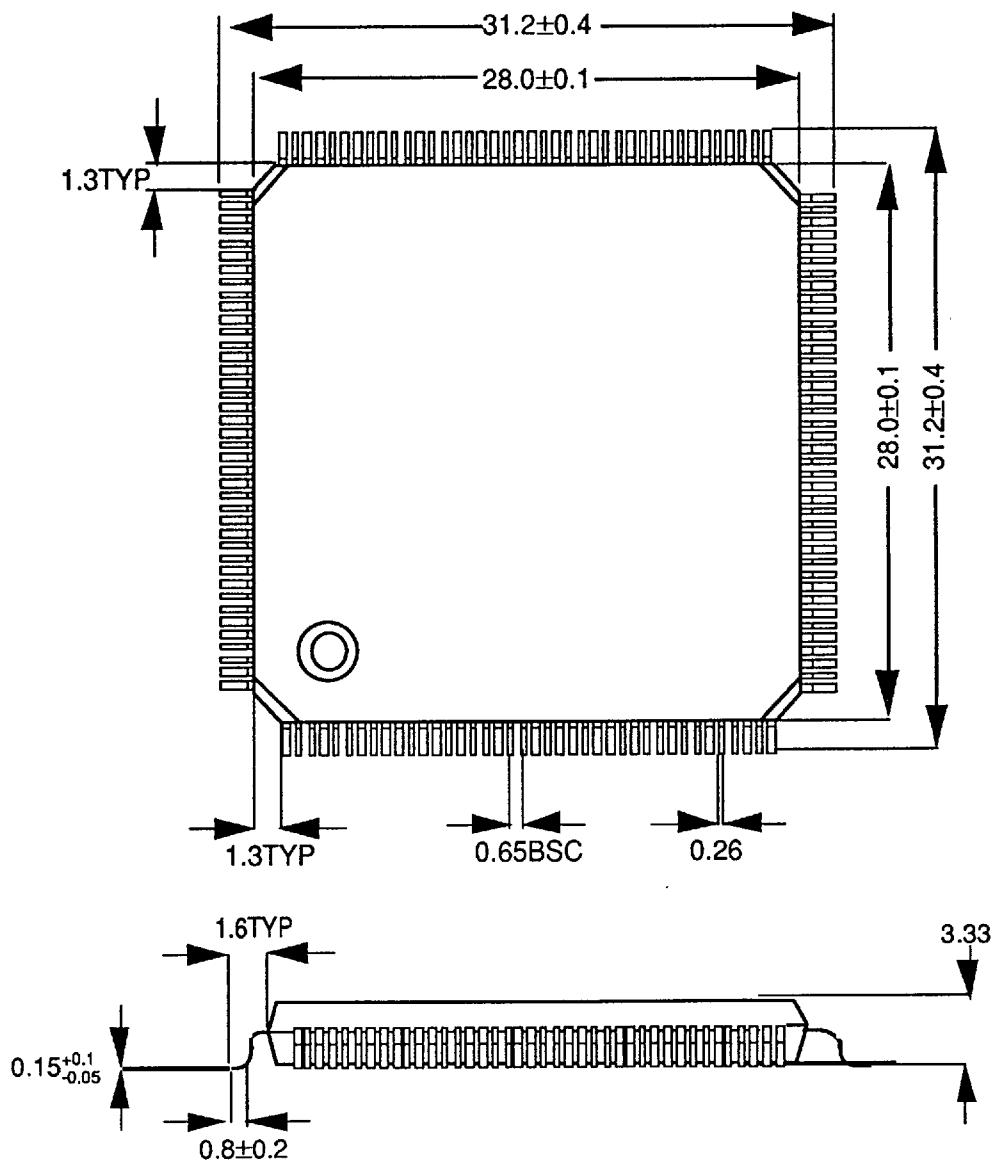


Figure 9. TVGA8900D Packaging PFP 160 Pins (dimensions in mm)